



/ Revised record

版本	修订日期	有修订的页码	修订涉及的内容	拟制	审核
A	2017-12				
B	2021-2-18	7	更新包装规格	黄超	刘晓荣



/ Descriptions

/ Features

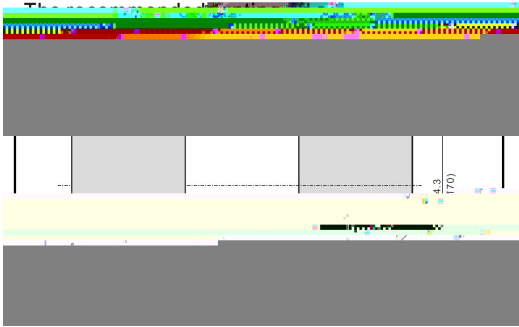
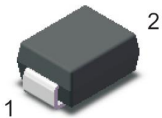
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/ Applications

/ Equivalent Circuit



/ Pinning



/ Marking



参数	参数符号	测试条件	数值						单位
		℃							

℃



/ Electrical Characteristic Curve

Fig.1 Maximum Average Forward Current (P_{avg})



Fig.2 Typical Reverse Characteristics



Fig.3 Typical Forward Characteristics

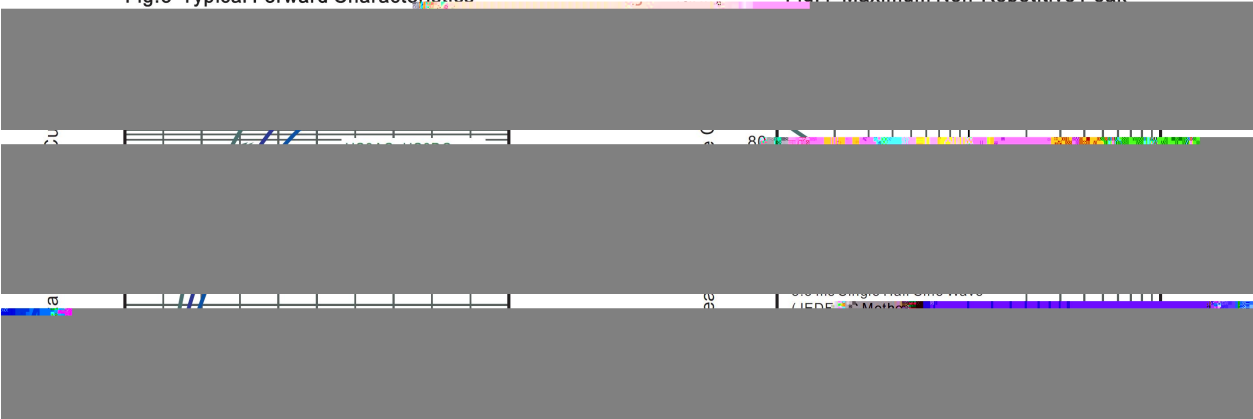
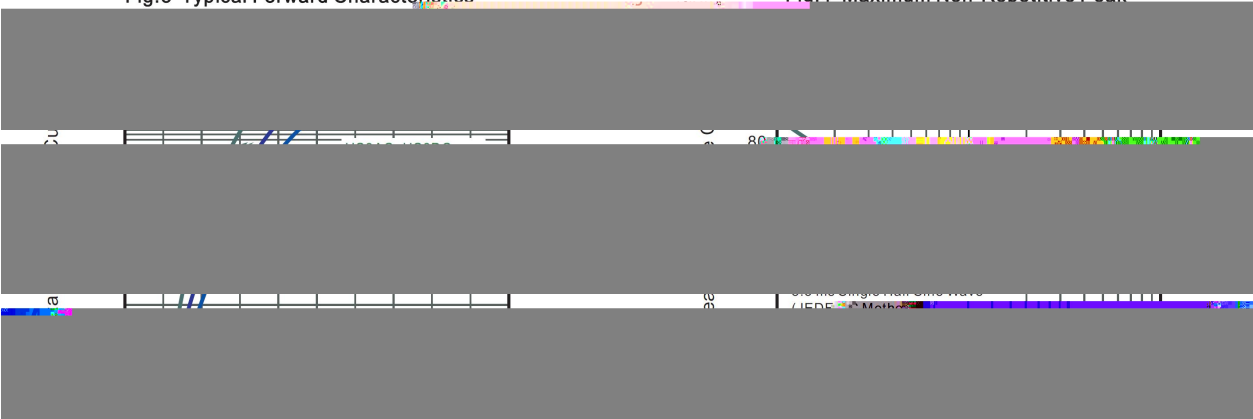


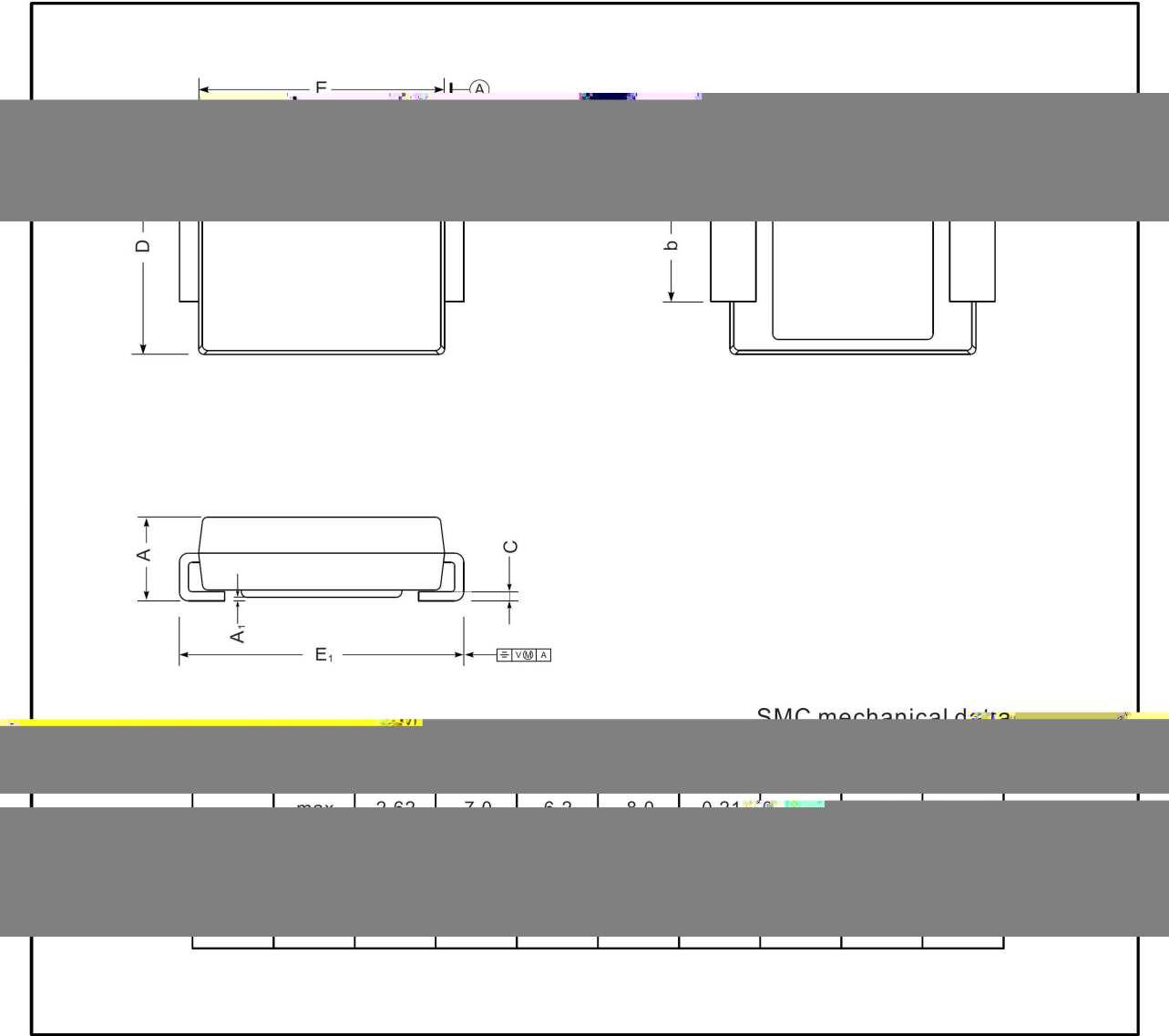
Fig.4 Maximum Non-Repetitive Peak





/ Package Dimensions

SMC





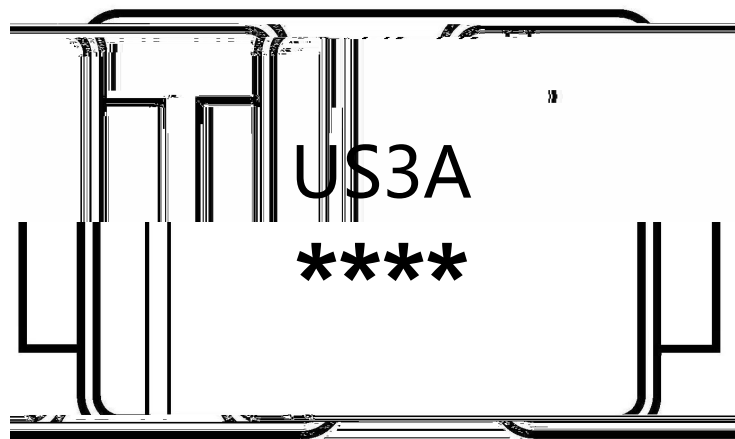
/ Marking Instructions

Marking

Type number	Marking code
US3AC	US3A



/ Marking Instructions



说明：

US3A： 为型号代码

****： 为生产批号追溯码，第 1 个*为年月代码，后面 3 个*为当月小批号代码

US3A：

****： , * , *



() / Temperature Profile for IR Reflow Soldering(Pb-Free)

